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November 26, 2003



MAIL STOP PATENT APPLICATION

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Re: Application of Hien Boon TAN and Anthony Yi Sheng SUN
HIGH DENSITY CHIP SCALE LEADFRAME PACKAGE AND METHOD OF
MANUFACTURING THE PACKAGE
Assignee: **UNITED TEST AND ASSEMBLY TEST CENTER LTD.**
Our Ref. Q78432

Dear Sir:

Attached hereto is the application identified above comprising thirty five (35) sheets of the specification, including the claims and abstract, ten (10) sheets of drawings, a copy of an executed Assignment and PTO 1595 form, and a copy of an executed Declaration and Power of Attorney.

The Government filing fee is calculated as follows:

Total claims	<u>26</u>	-	<u>20</u>	=	<u>6</u>	x	\$18.00	=	<u>\$108.00</u>
Independent claims	<u>7</u>	-	<u>3</u>	=	<u>4</u>	x	\$86.00	=	<u>\$344.00</u>
Base Fee									<u>\$770.00</u>

TOTAL FILING FEE	\$1222.00
Recordation of Assignment	\$40.00
TOTAL FEE	<u>\$1262.00</u>

Checks for the statutory filing fee of \$1222.00 and Assignment recordation fee of \$40.00 are attached. The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this transmittal letter is attached.



SUGHRUE MION, PLLC

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Benefit is claimed from:

Country

U.S. Provisional

Application No

60/429,315

Filing Date

November 27, 2002

Respectfully submitted,
SUGHRUE MION, PLLC

Attorneys for Applicant

By:

A handwritten signature in black ink, appearing to read 'Alan J. Kasper', written over a horizontal line.

Alan J. Kasper

Registration No. 25,426

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